

OSP on Arduino – Training – Appendix 3

Using the Arduino OSP evaluation kit – OTP burning of SAID



Sense the power of light

Part A3 – OTP burning of SAID

The customer area

The burning process

Burning in practice



OTP introduction

OTP in SAID

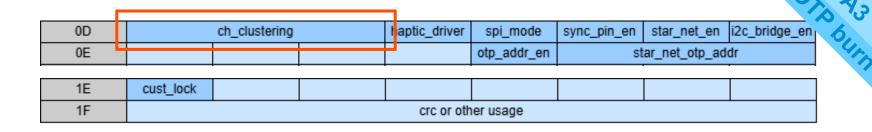
- The SAID has an OTP to store (configuration) data specific for itself
- OTP abbreviates One-Time Programmable memory
 - "One-time": Think of it as a bunch of fuses
 - "Memory": Intact, a fuse represents a 0; burned, it represents a 1
- The SAID OTP is split in two areas: foundry and customer
- foundry area
 - stores 13 bytes configuration data
 - set by ams-OSRAM during manufacturing
 - examples are trim values for the internal oscillator, voltage, ...
 - this area is locked for writing
- customer area
 - stores 19 bytes configuration data
 - set by the end-customer
 - 2 bytes (13 bits) are SAID hardware features the customer can configure
 - remaining 17 bytes are free, e.g. for color calibration values
 - this area has a lock, by default 0/unlocked, but the customer can write a 1/lock

address	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
00								
01								
02								
03								
04								
05				Fou	ndry			
06								
07				are	ea			
08				a i	-			
09								
0A								
0B								
0C								
0D		ch_clustering		haptic_driver	spi_mode	sync_pin_en	star_net_en	i2c_bridge_en
0E					otp_addr_en	st	tar_net_otp_ad	dr
0F								
10								
11								
12								
13								
14				0 -1				
15				Custo	omer			
16								
17				are	ea			
18								
19								
1A								
1B								
1C								
1D								
1E	cust_lock							
1F				crc or oth	ner usage			
				2.2.21 00				

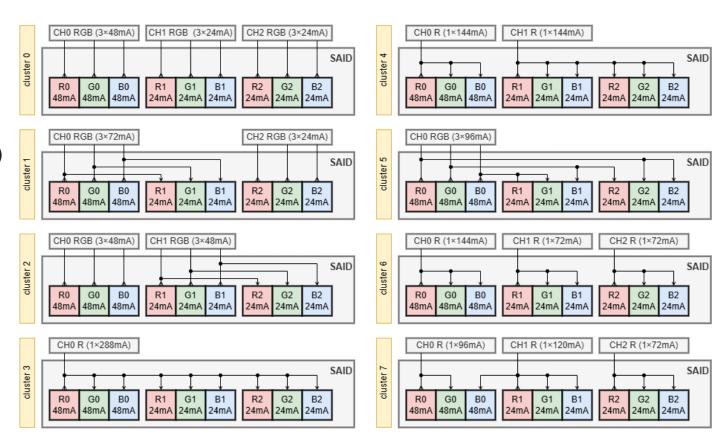


ch_clustering

For higher drive currents



- The SAID has 9 drivers (in 3 channels)
- Each capable of driving 24 mA or even 48 mA
- It is possible to cluster drivers
 - One driver becomes the main (triangle arrow tail)
 - the others the aggregates (arrow-head)
 - 8 clustering option available
- The PWM of main is enforced on its aggregates
- The current of main is enforced on its aggregates
- On the PCB:
 the main and aggregates need to be wired together
- The OTP:
 needs to be burned for the associated cluster mode
 in bits ch_clustering





haptic_driver

Using LED drivers for a haptic actuator

										O
0D		ch_clustering		haptic_driver		spi_mode	sync_pin_en	star_net_en	i2c_bridge_en	1
0E			L		C	tp_addr_en	st	ar_net_otp_ad	dr	
				•					·	
1E	cust_lock									
1F				crc or oth	ner	usage				

- When the haptic_driver bit is set in the OTP, the SAID acts as a driver for a haptic actuator
- This implicitly selects clustering mode 3 (all driver aggregated to one output)
- Gives a power of $\underbrace{48+48+48}_{\text{ch0}} + \underbrace{24+24+24}_{\text{ch1}} + \underbrace{24+24+24}_{\text{ch2}} = 288\text{mA}$
- Also, the driver frequency is implicitly divided by 4, resulting in 150 Hz mode or 300 Hz mode (see FAST_PWM)

PWM speed	FAST_PWM	PWM label	PWM actual	Haptic actual	Haptic label
Slow	0	500 Hz	586 Hz	146 Hz	150 Hz
Fast	1	1 000 Hz	1 172 Hz	293 Hz	300 Hz

7.13.8		READSETUP (0x4C) Read SETUP register. No payload. Answer is 8-bit.						
	Table 2	8: READSETUP re		READSETUP				
	Bit	Bit name	Default	Access	Bit description			
	7	FAST_PWM	0x0	RW	This bit allows to control the PWM speed and by this the dynamic range of the color: "0": 500Hz PWM frame rate with 15 bits dynamic range "1": 1000Hz PWM frame rate with 14 bits dynamic range			



spi_mode

Manchester or 2-wire SPI

0D		ch_clustering	haptic_drive	spi_mode	sync_pin_en	star_net_en	i2c_bridge_en	1
0E			_	otp_addr_en	st	ar_net_otp_ad	dr	
				•			·	
1E	cust_lock							
1F			crc or ot	her usage				

- The first SAID in the chain is typically configured for MCU mode (with a pull-up on P and a pull-down on N)
- By default, the MCU mode is of type A
 - Downstream telegrams ("commands") use Manchester encoding on P line
 - Upstream telegrams ("responses") use P line for DATA and N line for CLK
- By setting OTP bit spi_mode, the mode becomes type B aka 2-wire SPI
 - Downstream telegrams ("commands") and upstream telegrams ("responses") both use P line for DATA and N line for CLK
- "P2RAM-hackers": SAID would need to have this bit set before receiving reset and init, therefore, setting this bit in P2RAM is ineffective

MCU mode type A



MCU mode type B





sync_pin_en

Sync via telegram or pin

0D		ch_clustering	haptic_driver	spi_mode	sync_pin_en	star_net_en	i2c_bridge_en
0E				otp_addr_en	Sta	r_net_otp_ad	dr
1E	cust_lock						
1F			crc or oth	er usage			

- Sending setpwm telegrams to multiple nodes causes variation in their color/brightness-switch moment
- The SAID has a sync feature
- When the SYNC_EN bit is set in the CURRENT register, new PWM values are not applied until a sync signal is received
- The sync signal can be either software, given form the sync telegram, or hardware, from a toggling of the sync pin
- The OTP bit sync_pin_en configures the method (default 0 is telegram, 1 is sync pin)
- Pin B1 is used as the sync pin
- When **sync_pin_en** is set, B1 can no longer be used as LED driver

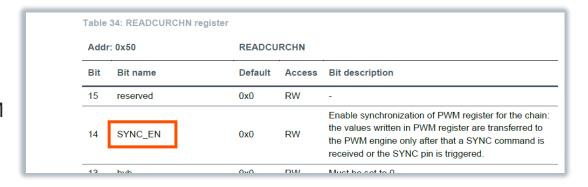


Table 2: Pin de	escription of	AS1163	
Pin number	Pin name	Pin type ⁽¹⁾	Description ⁽²⁾
QFN 3x3 16	•	•	
12	R2	ANA	Driver 0 of channel 2 (Red), also SDA
13	B1	ANA	Driver 2 of channel 1 (Blue), also SYNC
14	G1	ANA	Driver 1 of channel 1 (Green) also for parallel address configuration



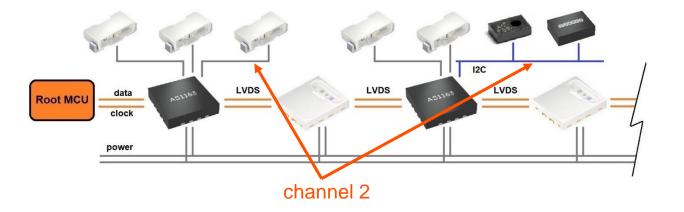
i2c_bridge_en

Configure channel 2 for I2C

0D		ch_clustering	haptic_driver	spi_mode	sync_pin_en	star_net_er	i2c_bridge_en
0E				otp_addr_en	st	ar_net_otp_a	ddi
						-	
1E	cust_lock						
1F			crc or oth	er usage			

- The SAID has a built-in I2C bridge
- This is an alternative function of the drivers in channel 2
- Enabled by setting i2c_bridge_en to 1
- When i2c_bridge_en is set,
 R2, G2, and B2 can no longer be used as LED driver

Pin number	Pin name	Pin type ⁽¹⁾	Description ⁽²⁾	
QFN 3x3 16		•		
10	B2	ANA	Driver 2 of channel 2 (Blue), als	o INT
11	G2	ANA	Driver 1 of channel 2 (Green), a	Iso SCL
12	R2	ANA	Driver 0 of channel 2 (Red), als	SDA
12	D1	ΛΝΛ	Driver 2 of shapped 4 (Plus) als	- CVNC





Star network

Enabling and setting a branch mask

0D		ch_clustering	haptic_driver	spi_mode	sync_pin_en	star_net_en	i2c_bridge_en
0E				otp_addr_en	st	ar_net_otp_ad	dr
			•				
1E	cust_lock						
1F			crc or oth	ner usage			

- The SAID supports star networks
- This is implemented as an address filter
- The filtering must be enabled and the filter mask configured
- To enable filtering set star_net_en in OTP to 1
- The SAID is then said to be a "branch starter"
- To set the filter in OTP, set otp_addr_en to 1
 and star_net_otp_addr to the wanted filter mask
- To set the filter via pins, set otp_addr_en to 0
 and use R1 and G1 (star_net_otp_addr remains unused)
- Pins R1 and G1 define the mask through a resistor configuration
- With star_net_en=1 and otp_addr_en=0,
 R1 and G1 can no longer be used as LED driver

_	"P2RAM-hackers": SAID would need to have these bits set before	-
	receiving reset and init therefore, setting these bits in P2RAM is ineffect	ive

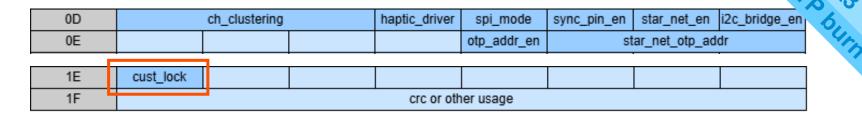
Pin number	Pin name	Pin type ⁽¹⁾	Description ⁽²⁾	
QFN 3x3 16	•	•		
14	G1	ANA	Driver 1 of channel 1 (Green), als	for parallel address configuration
15	R1	ANA	Driver 0 of channel 1 (Red), also f	or parallel address configuration
16	B0	ANA	Driver 2 of channel 0 (Blue)	

Table 10: Address mask configuration									
S1 R1		Internal bits	Corresponding parallel address						
VDD/2	VDD/2	00 00	0ь000						
VDD/2	GND	00 01	0b001						
VDD/2	VDD	00 10	0b010						
GND	VDD/2	01 00	0b011						
GND	GND	01 01	0b100						
GND	VDD	01 10	0b101						
VDD	VDD/2	10 00	0b110						
VDD	GND	10 01	0b111						



cust_lock

Blocking OTP modifications



- Once cust_lock has been set to 1, no more OTP modifications (customer area) are possible
- Option: use 1F as a CRC checksum area
- One could use the same CRC as for the telegrams; see aoosp_crc module; customer choice

Sense the power of light

Part A3 – OTP burning of SAID

The customer area

The burning process

Burning in practice



OTP mirror

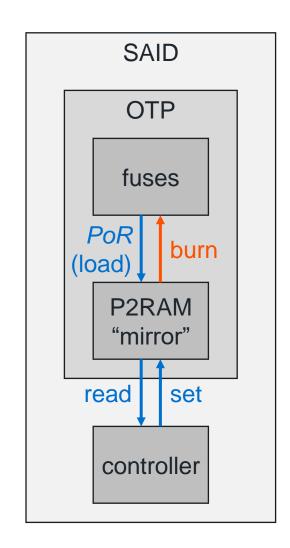
Also known as P2RAM

The OTP contents is mirrored in a RAM

- Known as the OTP mirror or as P2RAM
- Sometimes OTP means just fuses (narrow sense: "the persistent tech")
- Sometimes OTP means fuses+P2RAM (broad sense: "configuration store") [these slides]

Behavior

- At power-on reset ("PoR") the configuration bits are "copied" from the fuses to the mirror
- The controller in the SAID always reads config bits from the mirror, never from the fuses
- Telegrams can be sent to the controller to modify the mirror (readopt, setotp)
 The controller can then use the "new" bits
- These bits are in P2RAM, so not persistent, they are lost after a power cycle
 (also lost after a load telegram; a reset telegram does not (!) reload the mirror)
- The **burn** telegram burns the P2RAM into the fuses (making the configuration persistent)





Intermezzo on authenticating for OTP changes

Setting the SAID password

- Telegrams related to changing the OTP require elevated privileges
- Those telegrams include (for details, see next slides)
 - setotp
 - cust, burn, idle
 - gload, load
- The MCU must first authenticate by sending the correct password (using the settestpw() telegram)
- After sending this password, the SAID is in "authenticated mode"
- In authenticated mode, the SAID does not fully function (e.g. does not forward telegrams)
- Leave authenticated mode by sending the incorrect password (e.g. 0)
- The aolibs have a password store: function aoosp_said_testpw_get() returns the password
- This function is used by e.g. macro aoosp_exec_setotp() to set password, read/modify/write otp and clr password
- By default, the password store is empty, see aoosp_said_testpw_get() for options on how to fill it
- Ask ams-OSRAM representative for the actual SAID password



OTP burn process

First phase: preparing the OTP image

- First step is to prepare a configuration image in the P2RAM
- After a PoR all fuses are loaded into the P2RAM
- Make the SAID addressable (send a reset and an init telegram)
- Read the "old" (current) contents of the OTP (mirror) via telegrams readotp.
- Authenticate for OTP writes by sending the correct password (via telegram settestpw(act))
- Create "new" OTP image in P2RAM by sending setotp telegrams
- De-authenticate to make the SAID behave normal again (via telegram settestpw(0))
- The P2RAM mirror should now contain the desired image to be burned in OTP fuses
- Recall: every 1 in the fuses must be a 1 in the mirror a 1 can never be changed back to a 0
- Unless the lock is set, a next burn will be possible setting even more bits to 1 (e.g. lock bit)
- Next step is the actual burning



The "macro" function aoosp_exec_setotp() takes care of set pw, set OTP, clr pw

OTP burn process

Second phase: burning

2 BURN

- Second step is to burn the P2RAM image into the fuses
- Assumption is that we continue from previous step, so SAID is addressable and not authenticated
- Authenticate for burn by sending the correct password (via telegram settestpw(act))
- Make sure the customer area is activated (send telegram cust)
- Lower the supply voltage (see upcoming slides)
- Start the burning (copy P2RAM to fuses) by send telegram burn
- Wait 5ms for burning to be complete
- Deactivate the customer area (send telegram idle)
- Raise the supply voltage to normal
- De-authenticate to make the SAID behave normal again (via telegram settestpw(0))
- Next step is the verification



OTP burn process

Third phase: verification



- Third step is to verify the fuses are burned correctly
- Assumption is that we continue from previous step, so SAID is addressable and not authenticated
- Suggested is to first clear the P2RAM (e.g. writing 0xAA everywhere) with setotp;
 need to be authenticated for that
- Authenticate for load by sending the correct password (via telegram settestpw(act))
- Make sure the customer area is activated (send telegram cust)
- Suggested: configure wider guard-band for more thorough check (send telegram gload)
- Load the fuses into the P2RAM mirror (send telegram load)
- Deactivate the customer area (send telegram idle)
- De-authenticate to make the SAID behave normal again (via telegram settestpw(0))
- Check the P2RAM (and thus the fuses) have correct values (use readotp)



A A 3

Burning needs a low supply voltage

Using a lab power supply

The actual burn process needs to occur at 2V7

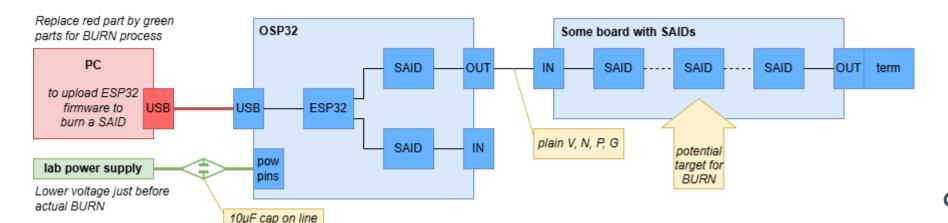
We can relatively easily try it on the OSP32 board – stretching the SAID specs

Flash the firmware sketch (that burns the OTP)

- Over USB flash the sketch that burns the firmware
- In the firmare, add a prompt for the operator to lower the voltage,
 the sketch waits (e.g. for press on A button) to start burning

Execute the firmware sketch to burn the OTP

- Replace USB cable with lab power supply; start at 5V, lower (without interruption) to 4V when prompted
- 4V is out-of-spec for SAID burning, but is needed for the 3V3 LDO on the OSP32 board (with headroom)





Sense the power of light

Part A3 – OTP burning of SAID

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Burning in practice



Complete example

aoosp_otpburn

The library aoosp comes with a complete example

- It is called aoosp_otpburn (link)
- By default, it writes a 0x01 to OTP location 0x1D for the SAID with address 0x003
- Gives prompt on OLED to lower and raise voltage, and waits for A-button

Notes

- User needs to get the SAID password and get that in the aolib's password store
- Need to flash firmware over USB, then replace USB by lab supply as shown before
- Can only try this sketch once, other runs need different OTP address or value
- Sketch does operate the SAID out of spec
- This leads to higher failures rates then wanted in mass production

address	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
00								
01								
02								
03								
04								
05								
06								
07								
08								
09								
0A								
0B								
0C								
0D		ch_clustering		haptic_driver	spi_mode	sync_pin_en	star_net_en	i2c_bridge_en
0E					otp_addr_en	st	tar_net_otp_ad	dr
0F								
10								
11								
12								
13								
14								
15								
16								
17								
18								
19								
1A								
1B								
1C								
1D	1							
1E	unt land							
	-							



Mass manufacturing

Lowering ppm failures

The OSP32 example will lead to higher failure rates (too high ppm due to wrong voltage)
The following sequence is proposed for mass production

- reset/init
- settestpw(act)
 - setotp
 - cust
 - burn
 - (within 15µs) lower voltage, wait (5ms), raise voltage
 - idle
 - optionally verify: setotp(0xFF), cust, gload, load, idle, readopt, compare
- settestpw(0)

This does require quick synchronization between sending the burn and lowering the voltage

For verification write some bit pattern to the mirror; here we used 0xFF



CIM OSRAM